

Qualified Vendors Lists (QVL)

DDR2-800 MHz capability

| Size | Vendor | Chip No. | SS/DS | Part No. | DIMM support | | |
|--------|-----------|--------------------|-------|----------------------|--------------|----|----|
| | | | | | A* | B* | C* |
| 512MB | KINGSTON | K4T51083QC | SS | KVR800D2N5/512 | • | • | • |
| 1024MB | KINGSTON | K4T51083QC | DS | KVR800D2N5/1G | • | • | • |
| 1024MB | KINGSTON | Heat-Sink Package | DS | KHX6400D2LL/1G | • | • | • |
| 1024MB | KINGSTON | Heat-Sink Package | SS | KHX6400D2LK2/1GN | • | • | • |
| 2048MB | KINGSTON | Heat-Sink Package | DS | KHX6400D2K2/2G | • | • | • |
| 512MB | Qimonda | HYB18T256800AF25F | DS | HYS64T64020HU-25F-A | • | • | • |
| 256MB | Qimonda | HYB18T512160BF-25F | SS | HYS64T32000HU-25F-B | • | • | • |
| 512MB | Qimonda | HYB18T512800BF25F | SS | HYS64T64000HU-25F-B | • | • | • |
| 1024MB | Qimonda | HYB18T512800BF25F | DS | HYS64T128020HU-25F-B | • | • | • |
| 512MB | SAMSUNG | EDD339XX | SS | M378T6553CZ3-CE7 | • | • | • |
| 256MB | SAMSUNG | K4T51163QC-ZCE7 | SS | M378T3354CZ3-CE7 | • | • | • |
| 512MB | SAMSUNG | ZCE7K4T51083QC | SS | M378T6553CZ3-CE7 | | • | • |
| 1024MB | SAMSUNG | ZCE7K4T51083QC | DS | M378T2953CZ3-CE7 | • | • | • |
| 512MB | Hynix | HY5PS12821BFP-S5 | SS | HYMP564U64BP8-S5 | • | • | • |
| 1024MB | Hynix | HY5PS12821BFP-S5 | DS | HYMP512U64BP8-S5 | • | • | • |
| 512MB | MICRON | 5JAIIZ9DQQ | SS | MT8HTF6464AY-80EA3 | • | • | • |
| 1024MB | MICRON | 5JAIIZ9DQQ | DS | MT16HTF12864AY-80EA3 | • | • | • |
| 512MB | MICRON | 5ZD22D9GKX | SS | MT8HTF6464AY-80ED4 | • | • | • |
| 1024MB | MICRON | 5ZD22D9GKX | DS | MT16HTF12864AY-80ED4 | • | • | • |
| 512MB | MICRON | 6CD22D9GKX | SS | MT8HTF6464AY-80ED4 | • | • | • |
| 1024MB | MICRON | 6CD22D9GKX | DS | MT16HTF12864AY-80ED4 | • | • | • |
| 512MB | CORSAIR | Heat-Sink Package | SS | CM2X512A-6400 | • | • | • |
| 1024MB | CORSAIR | Heat-Sink Package | DS | CM2X1024-6400C4 | • | • | • |
| 1024MB | ELPIDA | E1108AB-8E-E(ECC) | SS | E8E10EE8ABFA-8E-E | • | • | • |
| 2048MB | ELPIDA | E1108AB-8E-E(ECC) | DS | E8E21EE8ABFA-8E-E | | • | • |
| 512MB | A-DATA | N/A | SS | M20AD6G3H3160J1E52 | • | • | • |
| 512MB | A-DATA | AD29608A8A-25EG | SS | M20AD6G3H3160I1E5E | • | • | • |
| 512MB | Crucial | Heat-Sink Package | SS | BL6464AA804.8FD | • | • | • |
| 1024MB | Crucial | Heat-Sink Package | DS | BL12864AA804.16FD | • | • | • |
| 512MB | Apacer | Heat-Sink Package | SS | AHU512E800C5K1C | | | • |
| 1024MB | Apacer | Heat-Sink Package | DS | AHU01GE800C5K1C | | | • |
| 512MB | Transcend | K4T51083QC | SS | TS64MLQ64V8J | • | • | • |
| 1024MB | Transcend | K4T51083QC | DS | TS128MLQ64V8J | • | • | • |

DDR2-667 MHz capability

| Size | Vendor | Chip No. | SS/DS | Part No. | DIMM support | | |
|--------|----------|-----------------------|-------|---------------------|--------------|----|----|
| | | | | | A* | B* | C* |
| 256MB | KINGSTON | HYB18T256800AF3 | SS | KVR667D2N5/256 | | • | • |
| 512MB | KINGSTON | D6408TEBGLL3U | SS | KVR667D2N5/512 | • | • | • |
| 1024MB | KINGSTON | D6408TEBGLL3U | DS | KVR667D2N5/1G | • | • | • |
| 256MB | KINGSTON | HYB18T256800AF3S | SS | KVR667D2N5/256 | • | • | • |
| 256MB | Qimonda | HYB18T512160AF-3S | SS | HYS64T32000HU-3S-A | • | • | • |
| 512MB | Qimonda | HYB18T512800AF3S | SS | HYS64T64000HU-3S-A | • | • | • |
| 1024MB | Qimonda | HYB18T512800AF3S | DS | HYS64T128020HU-3S-A | • | • | |
| 256MB | Qimonda | HYB18T256800AF3S(ECC) | SS | HYS72T32000HU-3S-A | | • | |
| 512MB | Qimonda | HYB18T512800AF3S(ECC) | SS | HYS72T64000HU-3S-A | • | • | • |
| 1024MB | Qimonda | HYB18T512800AF3S(ECC) | DS | HYS72T128020HU-3S-A | • | • | • |
| 512MB | Qimonda | HYB18T512800BF3S(ECC) | SS | HYS72T64000HU-3S-B | • | • | |
| 1024MB | Qimonda | HYB18T512800BF3S(ECC) | DS | HYS72T128020HU-3S-B | • | • | |
| 256MB | Qimonda | HYB18T512160BF-3S | SS | HYS64T32000HU-3S-B | • | • | • |
| 512MB | Qimonda | HYB18T512800BF3S | SS | HYS64T64000HU-3S-B | • | • | • |
| 1024MB | Qimonda | HYB18T512800BF3S | DS | HYS64T128020HU-3S-B | • | • | • |
| 256MB | SAMSUNG | K4T51163QC-ZCE6 | SS | M378T3354CZ0-CE6 | • | • | |
| 512MB | SAMSUNG | ZCE6K4T51083QC | SS | M378T6553CZ0-CE6 | • | • | • |
| 256MB | SAMSUNG | K4T51163QC-ZCE6 | SS | M378T3354CZ3-CE6 | • | • | |
| 512MB | SAMSUNG | K4T51083QC | SS | M378T6553CZ3-CE6 | • | • | |
| 512MB | Hynix | HY5PS12821Afp-Y5 | SS | HYMP564U64AP8-Y5 | | | • |
| 1024MB | Hynix | HY5PS12821Afp-Y5 | DS | HYMP512U64AP8-Y5 | • | • | |
| 1024MB | Hynix | HY5PS1G831FP-Y5(ECC) | SS | HYMP112U72P8-Y5 | • | | • |
| 512MB | Hynix | HY5PS12821Afp-Y5(ECC) | SS | HYMP564U72AP8-Y5 | • | • | • |
| 1024MB | Hynix | HY5PS12821Afp-Y5(ECC) | DS | HYMP512U72AP8-Y5 | • | • | • |
| 512MB | Hynix | HY5PS12821Afp-Y4 | SS | HYMP564U64AP8-Y4 | • | • | • |
| 1024MB | Hynix | HY5PS12821Afp-Y4 | DS | HYMP512U64AP8-Y4 | • | • | |
| 512MB | Hynix | HY5PS12821Afp-Y4(ECC) | SS | HYMP564U72AP8-Y4 | • | • | • |
| 1024MB | Hynix | HY5PS12821Afp-Y4(ECC) | DS | HYMP512U72AP8-Y4 | • | • | |
| 256MB | CORSAIR | MIIIO0605 | SS | VS256MB667D2 | | • | • |
| 512MB | CORSAIR | 64MBCFEG | SS | VS512MB667D2 | • | • | • |
| 1024MB | CORSAIR | 64MBCFEG | DS | VS1GB667D2 | • | • | • |
| 256MB | ELPIDA | E2508AB-6E-E | SS | EBE25UC8ABFA-6E-E | • | • | • |
| 512MB | ELPIDA | E5108AE-6E-E | SS | EBE51UD8AEFA-6E-E | • | • | • |
| 512MB | A-DATA | AD29608A8A-3EG | SS | M20AD5G3H3166I1C52 | • | • | • |
| 1024MB | A-DATA | AD29608A8A-3EG | DS | M20AD5G3I4176I1C52 | • | • | • |

(continued on the next page)

DDR2-667 MHz capability

| Size | Vendor | Chip No. | SS/DS | Part No. | DIMM support | | |
|--------|--------------|---------------------|-------|--------------------|--------------|----|----|
| | | | | | A* | B* | C* |
| 512MB | crucial | Heat-Sink Package | SS | BL6464AA663.8FD | • | • | • |
| 1024MB | crucial | Heat-Sink Package | DS | BL12864AL664.16FD | • | • | • |
| 1024MB | crucial | Heat-Sink Package | DS | BL12864AA663.16FD2 | • | • | • |
| 1024MB | Apacer | E5108AE-6E-E | DS | 78.01092.420 | • | • | • |
| 512MB | Apacer | AM4B5708GQJS7E0628F | SS | AU512E667C5KBGC | • | • | • |
| 1024MB | Apacer | AM4B5708GQJS7E | DS | AU01GE667C5KBGC | • | • | • |
| 512MB | Kingmax | KKEA88B4LAUG-29DX | SS | KLCC28F-A8KB5 | • | • | • |
| 1024MB | Kingmax | KKEA88B4LAUG-29DX | DS | KLCD48F-A8KB5 | • | • | • |
| 512MB | Transcend | E5108AE-6E-E | SS | TS64MLQ64V6J | • | • | • |
| 1024MB | Transcend | E5108AE-6E-E | DS | TS128MLQ64V6J | • | • | • |
| 512MB | Transcend | J12Q3AB-6 | SS | JM367Q643A-6 | • | • | • |
| 1024MB | Transcend | J12Q3AB-6 | DS | JM388Q643A-6 | • | • | • |
| 512MB | Super Talent | Heat-Sink Package | SS | T6UA512C5 | • | • | • |
| 1024MB | Super Talent | Heat-Sink Package | DS | T6UB1GC5 | • | • | • |
| 512MB | SMART | G64M8XB3ITIX4TUE | SS | TB3D2667C58S | • | • | • |
| 512MB | SMART | G64M8XB3ITIX4TUE | DS | TB4D2667C58D | • | • | • |

DDR2-533 MHz capability

| Size | Vendor | Chip No. | SS/DS | Part No. | DIMM support | | |
|--------|--------------|-----------------------|-------|----------------------|--------------|----|----|
| | | | | | A* | B* | C* |
| 512MB | Qimonda | HYB18T512800AF37 | SS | HYS64T64000HU-3.7-A | • | • | |
| 1024MB | Qimonda | HYB18T512800AF37 | DS | HYS64T128020HU-3.7-A | • | • | • |
| 2048MB | Qimonda | HYB18T1G800AF-3.7 | DS | HYS64T256020HU-3.7-A | | • | |
| 256MB | Qimonda | HYB18T5121608BF-3.7 | SS | HYS64T32000HU-3.7-B | • | • | |
| 512MB | Qimonda | HYB18T512800BF37 | SS | HYS64T64000HU-3.7-B | • | • | • |
| 1024MB | Qimonda | HYB18T512800BF37 | DS | HYS64T128020HU-3.7-B | • | • | • |
| 256MB | Qimonda | HYB18T256800AF37(ECC) | SS | HYS72T32000HU-3.7-A | • | | |
| 1024MB | Qimonda | HYB18T512800AF37(ECC) | DS | HYS72T128020HU-3.7-A | • | • | • |
| 256MB | SAMSUNG | K4T51163QC-ZCD5 | SS | M378T3354CZ3-CD5 | • | | |
| 512MB | Hynix | HY5PS12821F-C4 | SS | HYMP564U648-C4 | • | • | • |
| 512MB | Hynix | HY5PS12821F-C4(ECC) | SS | HYMP564U728-C4 | • | • | • |
| 1024MB | Hynix | HY5PS12821FP-C4 | DS | HYMP512U648-C4 | • | | |
| 512MB | Hynix | HY5PS12821AFP-C3 | SS | HYMP564U64AP8-C3 | • | • | |
| 1024MB | Hynix | HY5PS12821AFP-C3 | DS | HYMP512U64AP8-C3 | • | • | • |
| 512MB | CORSAIR | MI110052432M8CEC | DS | VS512MB533D2 | • | • | • |
| 1024MB | CORSAIR | 64M8CEDG | DS | VS1GB533D2 | • | • | |
| 512MB | KINGMAX | E5108AE-5C-E | SS | KLBC28F-A8EB4 | • | • | |
| 1024MB | KINGMAX | E5108AE-5C-E | DS | KLBD48F-A8EB4 | | • | |
| 512MB | KINGMAX | KKEA88E4AAK-37 | SS | KLBC28F-A8KE4 | • | • | |
| 1024MB | KINGMAX | 5MB22D9DCN | DS | KLBD48F-A8ME4 | | • | • |
| 512MB | Super Talent | Heat-Sink Package | SS | T5UA512C4 | | • | |
| 1024MB | Super Talent | Heat-Sink Package | DS | T5UB1GC4 | • | • | • |

Side(s): SS - Single-sided DS - Double-sided

DIMM support:

- A - Supports one module inserted in any slot as Single-channel memory configuration
- B - Supports one pair of modules inserted into either the blue slots or the black slots as one pair of Dual-channel memory configuration
- C - Supports 4 modules inserted into both the blue slots and the black slots as two pairs of Dual-channel memory configuration